



Product Change Notification

109220 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 109220 - 00
Change Title: 41110 and 41210 Serial-to-Parallel PCI Bridge, PCN 109220-00, Transport Media, Tray Design
Date of Publication: March 13, 2009

Key Characteristics of the Change:

Transport Media

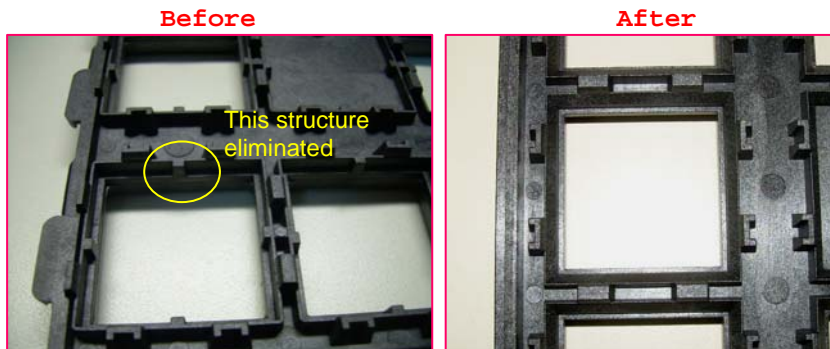
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	April 13, 2009
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Description of Change to the Customer:

In order to avoid ball damage issues from mis-orientation, Intel has made a slight design change to the shipping tray for the products listed below. The new tray will eliminate the mid-span structure to provide better protection to units. The tray material changed from - Modified Poly Sulfone (MPSU) to Modified Polyphenylene oxide (MPP0) for better mechanical strength. There is no change to critical for Function (CTF) dimensions or to outer dimensions of the tray. There is no change to the unit seating locations or to the tray to tray stacking.

See diagram below:



Customer Impact of Change and Recommended Action:

No customer impact anticipated. Customers may receive product packed in either tray until current inventory is depleted.

Products Affected / Intel Ordering Codes:

Marketing Name	Pre Conversion Product Code	Pre Conversion S-Spec	Pre Conversion MM#
1210 Serial-to-Parallel PCI Bridge	NQ41210 S L7JE	S L7JE	860909
1210 Serial-to-Parallel PCI Bridge	QG41210 S L8DS	S L8DS	869598
1110 Serial-to-Parallel PCI Bridge	NQ41110 S L93T	S L93T	878375
1110 Serial-to-Parallel PCI Bridge	QG41110 S L93U	S L93U	878377

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

Revision Number:

Reason:

March 13, 2009

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Originally Published PCN